

HTT1213E

Silicon NPN Epitaxial Twin Transistor

HITACHI

ADE-208-1449(Z)

Preliminary

Rev. 0

Aug. 2001

Features

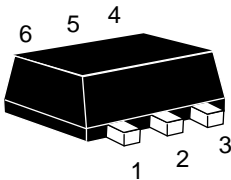
- Include 2 transistors in a small size SMD package: EMFPAK-6 (6 Leads: 1.2 x 0.8 x 0.5 mm)

Q1: Equivalent Buffer Transistor	Q2: Equivalent OSC Transistor
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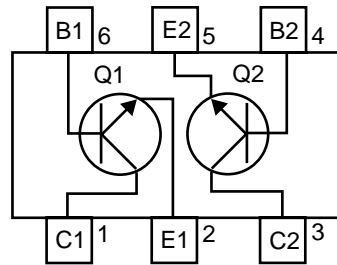
2SC5700	2SC5700
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Outline

EMFPAK-6



Internal Connection



- | | |
|-----------------|---------------|
| 1. Collector Q1 | 4. Base Q2 |
| 2. Emitter Q1 | 5. Emitter Q2 |
| 3. Collector Q2 | 6. Base Q1 |

Note: Marking is "E".

HTT1213E

Absolute Maximum Ratings

($T_a = 25\text{ }^\circ\text{C}$)

Item	Symbol	Ratings	
		Q1 and Q2	Unit
Collector to base voltage	V_{CBO}	15	V
Collector to emitter voltage	V_{CEO}	4	V
Emitter to base voltage	V_{EBO}	1.5	V
Collector current	I_C	50	mA
Collector power dissipation	P_C	Total 200*	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

*Value on PCB. (FR-4(13 x 13 x 0.635 mm))

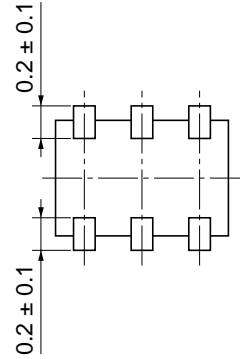
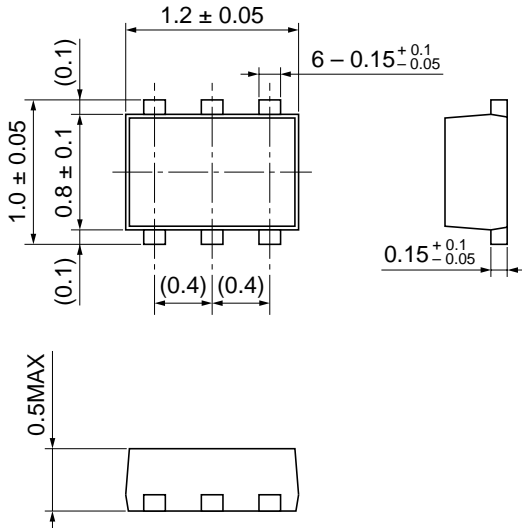
Electrical Characteristics (Q1 and Q2)

($T_a = 25\text{ }^\circ\text{C}$)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	15	—	—	V	$I_C = 10\text{ }\mu\text{A}$, $I_E = 0$
Collector cutoff current	I_{CBO}	—	—	0.1	mA	$V_{CB} = 15\text{ V}$, $I_E = 0$
Collector cutoff current	I_{CEO}	—	—	1	mA	$V_{CE} = 4\text{ V}$, $R_{BE} = \text{infinite}$
Emitter cutoff current	I_{EBO}	—	—	0.2	mA	$V_{EB} = 0.8\text{ V}$, $I_C = 0$
DC current transfer ratio	h_{FE}	100	130	170	—	$V_{CE} = 1\text{ V}$, $I_C = 5\text{ mA}$
Reverse transfer capacitance	C_{fe}	—	0.30	0.45	pF	$V_{CB} = 1\text{ V}$, $f = 1\text{ MHz}$ Emitter ground
Gain bandwidth product	f_T	10	12	—	GHz	$V_{CE} = 1\text{ V}$, $I_C = 5\text{ mA}$, $f = 1\text{ GHz}$
Forward transfer coefficient	$ S_{21} ^2$	13	16	—	dB	$V_{CE} = 1\text{ V}$, $I_C = 5\text{ mA}$, $f = 900\text{ MHz}$,
Noise figure	NF	—	1.0	2.0	dB	$\Gamma_S = \Gamma_L = 50\text{ }\Omega$

Package Dimensions

Unit: mm



Hitachi Code	EMFPAK-6
JEDEC	—
EIAJ	Conforms
Mass (reference value)	1.2 mg

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